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## (12) United States Patent Joyce

# (54) SOLID IMAGE APPARATUS WITH IMPROVED PART SEPARATION FROM THE IMAGE PLATE

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- (52) **U.S. CI.**CPC ...... **B29C 67/0096** (2013.01); **B29C 67/0066**(2013.01); **B29C 67/0085** (2013.01); **B29K**2105/0058 (2013.01); **B33Y 30/00** (2014.12);
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See application file for complete search history.

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#### (57) ABSTRACT

Devices, methods, and computer program products for facilitating the assembly of three-dimensional parts in a layer-wise fashion are disclosed, wherein separation forces between the assembler device and the parts are minimized at certain interfaces. Parts may be produced from polymers, photopolymers, metals, or other materials. In some aspects of the present disclosure, separation forces are minimized via the utilization of a cure inhibiting layer on a top surface of the image plate and via sliding the part from contact with a portion of the image plate having high elevation to above a portion of the image plate with low elevation. In some aspects, the assembler device further comprises a sweeper configured to expose the cure inhibiting layer to a source of cure inhibitor after a cure cycle.

#### 20 Claims, 8 Drawing Sheets

